AN2615
Application note

A high precision, low cost, single supply ADC for positive and negative input voltages

Introduction

In general the ADC embedded in the ST7 microcontroller is enough for most applications. But, in some cases it is necessary to measure both positive and negative voltages. This requires an external ADC with this particular capability. Most external ADCs require a dual supply to be able to do this. However, microcontroller-based applications usually only have a positive supply available.

This application note describes a technique for implementing an ADC for measuring both positive and negative input voltages while operating from a single (positive) supply. This converter is based on a voltage-to-time conversion technique. Like other slope converters, this ADC also uses an integrating capacitor, but the measured time is inversely proportional to the input voltage. An additional comparator with a voltage reference is used to improve conversion accuracy.

As shown in the circuit diagram (*Figure 1 on page 6*), the converter is implemented using an integrating capacitor, resistor, external op-amp, comparators and some microcontroller I/O pins. The ST72F264 microcontroller is used in this application note as an example, but the implementation is feasible using any ST7 microcontroller. The 16-bit timer of the microcontroller measures the time using its input capture pins (PB0 and PB2). These pins are connected to the output of the Comp1 and Comp2 comparators. The I/O pins PB1 and PB3 are used to switch the M1 and M2 switches on or off. The circuit could also work with a microcontroller equipped with an 8-bit timer. Only a small modification to the software would be needed.

Contents

1 **Circuit diagram** 6

2 **Theory of operation** 7

2.1 Advantage of using two comparators 7

3 **Timing diagram** 8

4 **Circuit analysis** 9

5 **V_{out} vs time diagram for different input voltages** 10

6 **Characteristics of different slope converters** 11

6.1 Single-slope converter 11

6.1.1 Single-slope converter timing diagram 11

6.2 Dual-slope converter 12

6.2.1 Dual-slope converter timing diagram 12

6.3 Solution presented in this application note 13

7 **Error analysis/constraints** 14

7.1 Input offset voltage 14

7.2 Correction factor for the product of R*C 14

7.3 Value of charging resistance R 14

7.4 Charging capacitor C 14

7.5 16-bit timer 15

7.6 Effect of temperature 15

7.7 Comparator 15

8 **Voltage references** 16

9 **Hardware setup** 17

10 **Algorithm** 18

11 **Result** 19

11.1 Positive input 19
11.2 Negative input 23
11.3 Effect of the capacitor value 26

12 Conclusion 27

13 References and bibliography 28

Appendix A Input stage conditions. 29
A.1 Case 1: Voltage measurement 29
A.2 Case 2: Current measurement 30

Appendix B Application board schematics 31

Appendix C Bill of materials 32

Appendix D Software flow 34
D.1 Code size 35

14 Revision history 36

List of tables

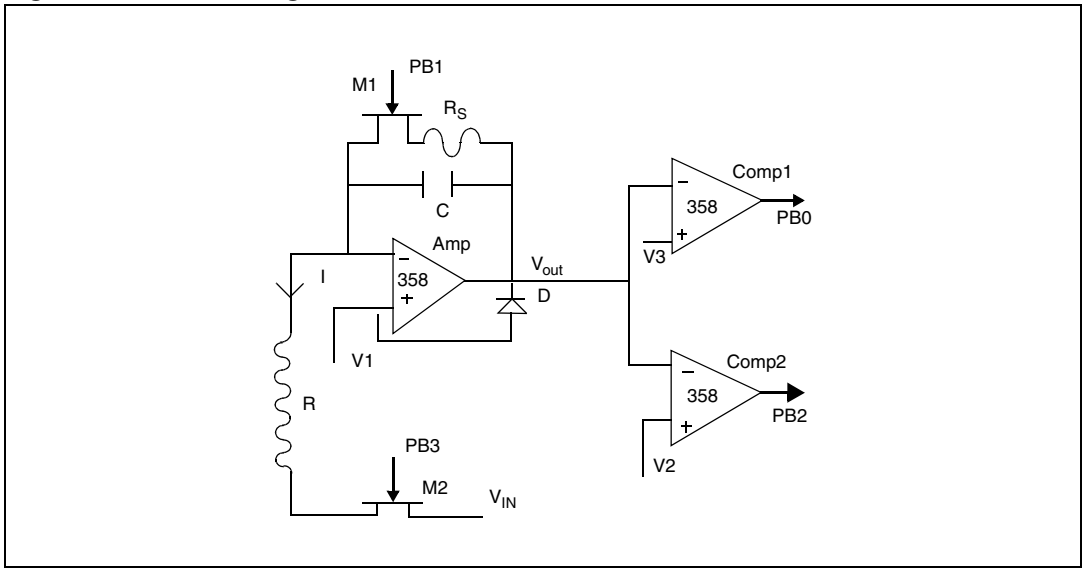
Table 1. Results for positive input voltages 20
Table 2. Results for negative input voltages 24
Table 3. Bill of materials 32
Table 4. Code size 35
Table 5. Document revision history 36

List of figures

Figure 1. Circuit diagram . . . 6
Figure 2. Relationship between Vout and time for a given input . . . 7
Figure 3. Timing diagram . . . 8
Figure 4. V_{out} vs time for different input voltages . . . 10
Figure 5. Single-slope converter circuit diagram . . . 11
Figure 6. Single-slope converter timing diagram . . . 11
Figure 7. Dual-slope converter circuit diagram . . . 12
Figure 8. Dual-slope converter timing diagram . . . 12
Figure 9. V_{IN} versus time in AN2615 solution . . . 13
Figure 10. Voltage reference . . . 16
Figure 11. Hardware setup . . . 17
Figure 12. Algorithm flowchart . . . 18
Figure 13. Results for positive input . . . 19
Figure 14. Measured vs input for positive voltages . . . 22
Figure 15. Error vs input for positive input voltages . . . 22
Figure 16. Results for negative input . . . 23
Figure 17. Measured vs input for negative voltages . . . 25
Figure 18. Error vs input for negative input voltages . . . 25
Figure 19. Results for positive input with a 10 µF capacitor . . . 26
Figure 20. Voltage measurement . . . 29
Figure 21. Potential divider . . . 29
Figure 22. Use of input buffer for voltage measurement . . . 30
Figure 23. Current measurement . . . 30
Figure 24. Application board schematics . . . 31

1 Circuit diagram

Figure 1. Circuit diagram



1. V1 < V2 < V3

2 Theory of operation

V_{in} is the input voltage. The voltages across resistor R are the reference voltage V_1 and the input voltage V_{in}. Due to the properties of the op-amp, V_1 is output on the inverting pin of the op-amp. Therefore, for a given input voltage, the current flowing through resistor R is constant. Let this current be I.

Current I charges the capacitor C, and output starts increasing in a positive direction for the input $V_{in} <= V_1$ (input $V_{in} > V_1$ charges in the opposite direction).

The output is captured at two instants using the two output comparators at voltage references V_2 and V_3. The time corresponding to voltage levels V_2 and V_3 are T_2 and T_3 respectively. The final reading of time T_m is taken as the difference of T_3 and T_2.

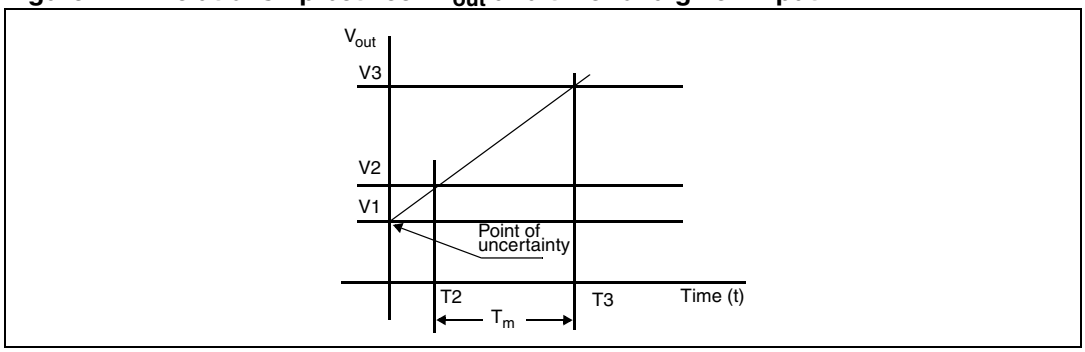
The input voltage is calculated from this difference through the formulae given in the circuit analysis.

This technique can only be used where the input voltage varies slowly, otherwise the charging of the capacitor is non-linear.

2.1 Advantage of using two comparators

The purpose of using the second comparator (comp2) can be understood from the diagram below (*Figure 2*), which shows the relationship between the op-amp output (Amp in *Figure 1: Circuit diagram on page 6*) and the time for a given input value.

Figure 2. Relationship between V_{out} and time for a given input



The time is measured as the difference of the two timer readings (T3 -T2) for the same slope. So factors like the residual voltage of the capacitor ($V_c(0+)$) and any other constant errors (like the effect of output offset voltage) on the output side of the op-amp are subtracted. So its performance is better than a single-slope converter.

3 Timing diagram

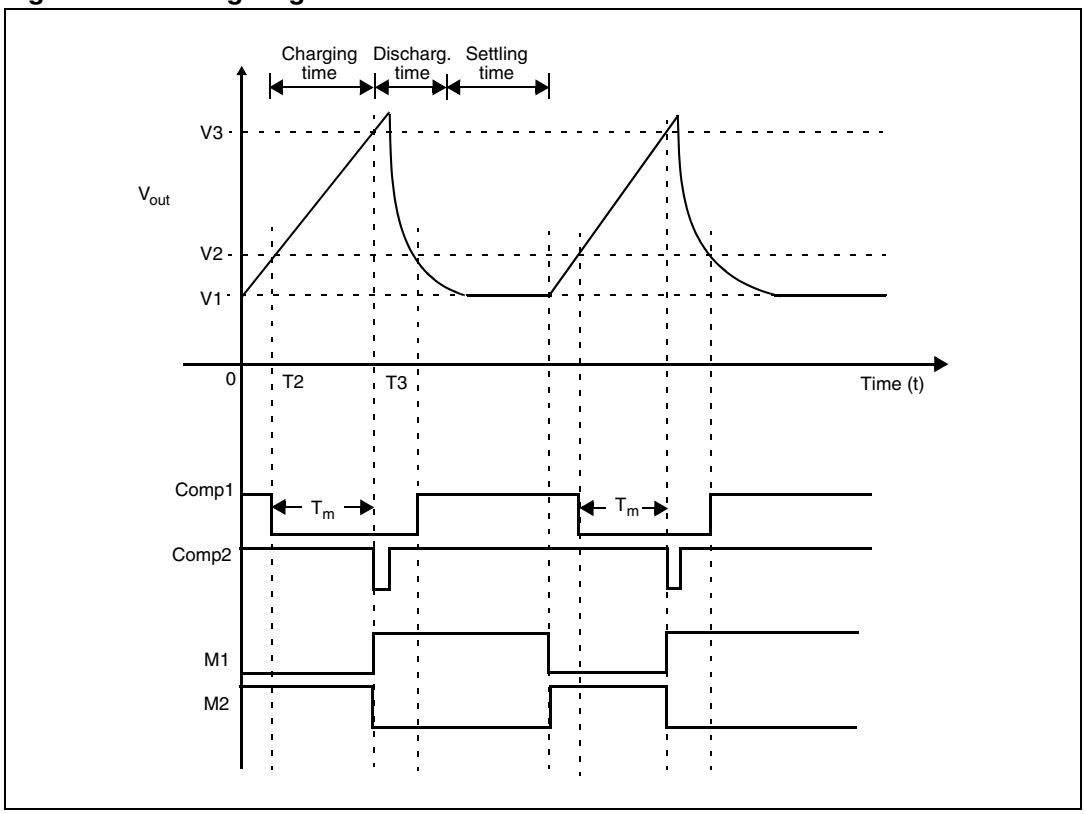
Figure 3 shows the overall operation of the ADC. Initially the capacitor is in the reset state (M1- on and M2- off), the op-amp output V_{out} is at V_1 and so, the output of both comparators, Comp1 and Comp2 is high.

Capacitor charging can be started by switching M1 - off and M2 - on. When the charging starts, V_{out} rises. When V_{out} becomes greater than V_2, a falling edge occurs on Comp1. This causes an input capture at pin PB2 and software reads the timer value T_2.

When V_{out} becomes greater than V_3, a falling edge occurs on Comp2. Again this causes an input capture at pin PB0 and software reads the timer value T_3.

The capacitor is discharged by switching M1 - on and M2- off. After this, the ADC can be kept in reset condition by switching M1 - on and M2 - off or we can continue repeating the same process and make more measurements.

Figure 3. Timing diagram



4 Circuit analysis

In this analysis, it is assumed that there is no noise present and the i/p offset voltage of the op-amp is negligible.

$$I = (V_1 - V_{in})/R = C * dV_c/dt$$

Where, $V_c = V_{out} - V_1$ and current 'I' is constant for a given input.

Applying the Laplace transform:

$$(V_1 - V_{in})/s * R = C * (s\ V_c(s) - V_c\ (0+))$$

or,

$$(V_1 - V_{in})/s^2 = (R * C) * (\ V_c\ (s)\ - V_c(0+)/s)$$

Applying the inverse Laplace transform, we get

$$(V_1 - V_{in}) * T = (R * C) * (\ V_c(t)\ - V_c(0+)\ ) \quad \text{---------- (1)}$$

As shown in *Figure 3: Timing diagram on page 8*

At $T = T_2$, $V_c(T_2) = V_2 - V_1$

And, at $T = T_3$, $V_c\ (T_3) = V_3 - V_1$

So,

$$(V_1 - V_{in}) * T_2 = (R * C) * (V_2 - V_1 - V_c(0+)) \quad \text{---------- (2)}$$

And,

$$(V_1 - V_{in}) * T_3 = (R * C) * (V_3 - V_1 - V_c(0+)) \quad \text{---------- (3)}$$

Equation (2) and equation (3) can both be used as the characteristic equation for this converter, but factors like Vc(0+) and other constant errors remain present. But if we use both comparators, then we can remove these factors by subtracting equation (2) and equation (3).

After subtracting equation (2) from equation (1) and rearranging we get:

$$V_{in} = V_1 - (R * C) *(\ V_3 - V_2\ )/(T_3 - T_2) \quad \text{---------- (4)}$$

Let measured time $T_3 - T_2 = T_m$ and we get:

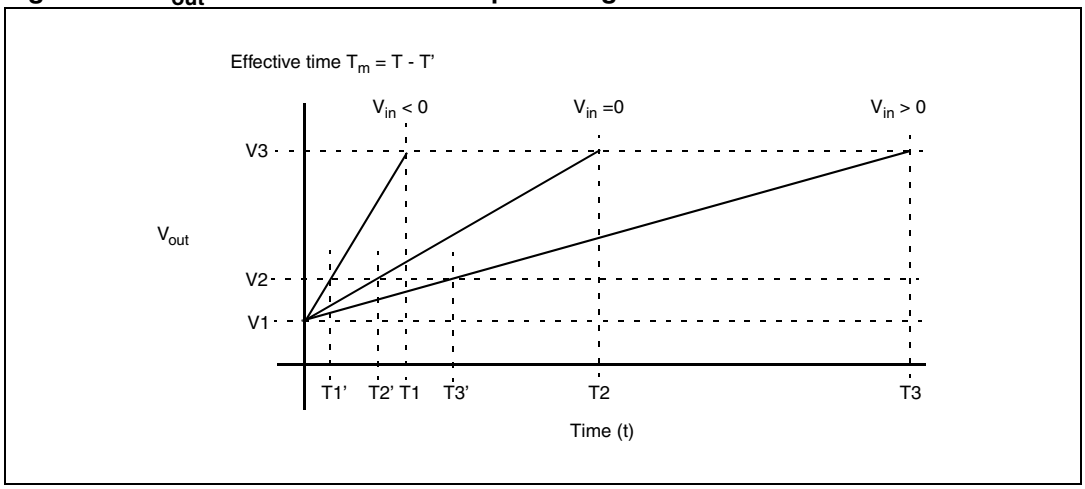
$$V_{in} = V1 - (R * C) * (\ V_3 - V_2\ )/T_m \quad \text{---------- (5)}$$

By using equation (5) we can measure the value of V_{in} depending on the value of T_3 and T_2.

5 V_{out} vs time diagram for different input voltages

In *Figure 4*, we can see the relationship between the V_{out} and time for different input voltages. From the figure, it is clear that the conversion time for a negative input voltage is less than the time taken for a positive input voltage.

Figure 4. V_{out} vs time for different input voltages

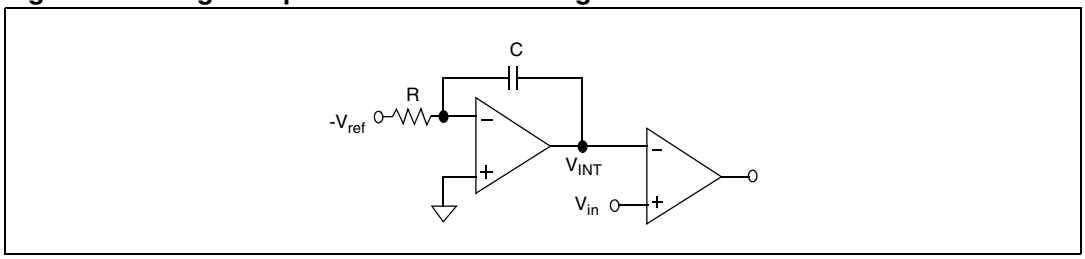


1. T_m1: for $V_{in} < 0$; T_m2: for $V_{in} = 0$; and T_m3: for $V_{in} > 0$ (where Tin1 < Tin2 < Tin3)
2. This ADC works for the range $V_{in} <= V_1$ but if the input voltage is greater than V_1 the direction of current I is inverted and the capacitor starts charging in the opposite direction and conversion never takes place.
3. For negative voltage currents I, that depend on the difference $V_1 - V_{in}$, is high, so the charging time for negative voltages is less than the positive voltages.

6 Characteristics of different slope converters

6.1 Single-slope converter

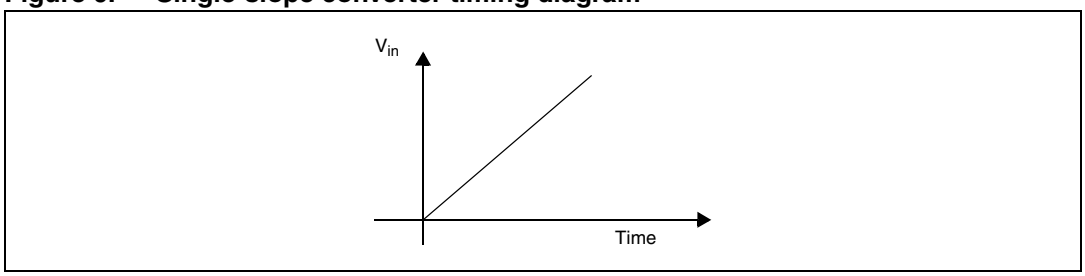
Figure 5. Single-slope converter circuit diagram



6.1.1 Single-slope converter timing diagram

Here V_{in} is directly proportional to the time measured.

Figure 6. Single-slope converter timing diagram



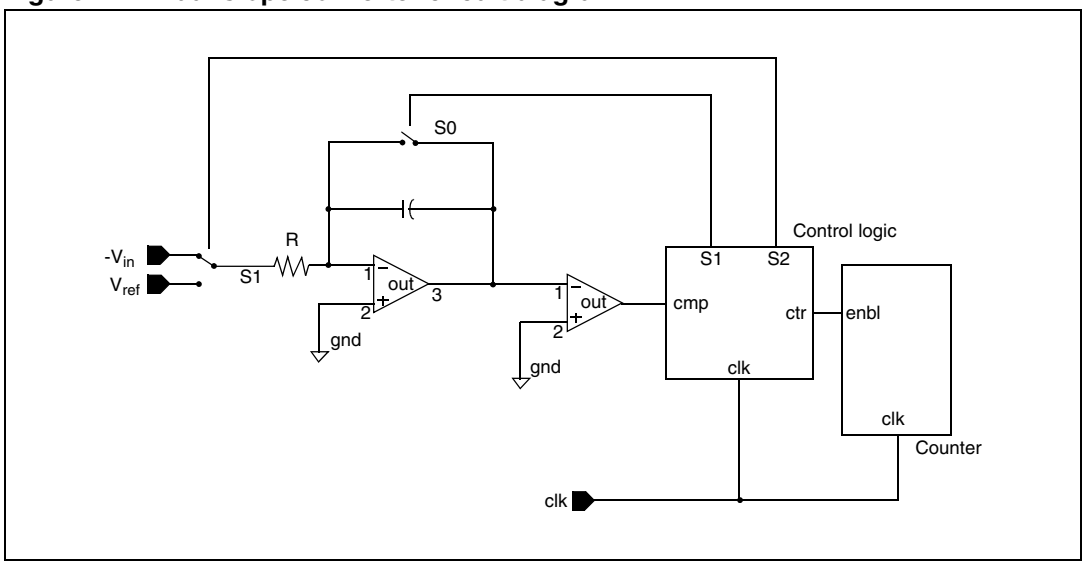
1. Here $V_{in} = K * T_m$

The major sources of conversion errors are the correction factor for the R*C product and the input offset voltage.

A single-slope converter requires a dual supply voltage op-amp to be able to measure the positive and negative voltages.

6.2 Dual-slope converter

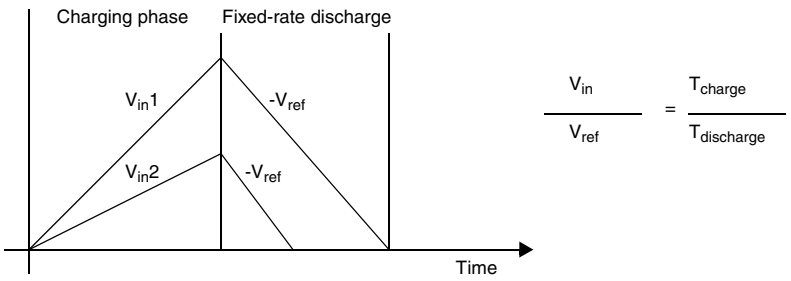
Figure 7. Dual-slope converter circuit diagram



6.2.1 Dual-slope converter timing diagram

As shown in *Figure 8* a dual-slope ADC has a charging phase followed by a fixed rate discharging phase.

Figure 8. Dual-slope converter timing diagram

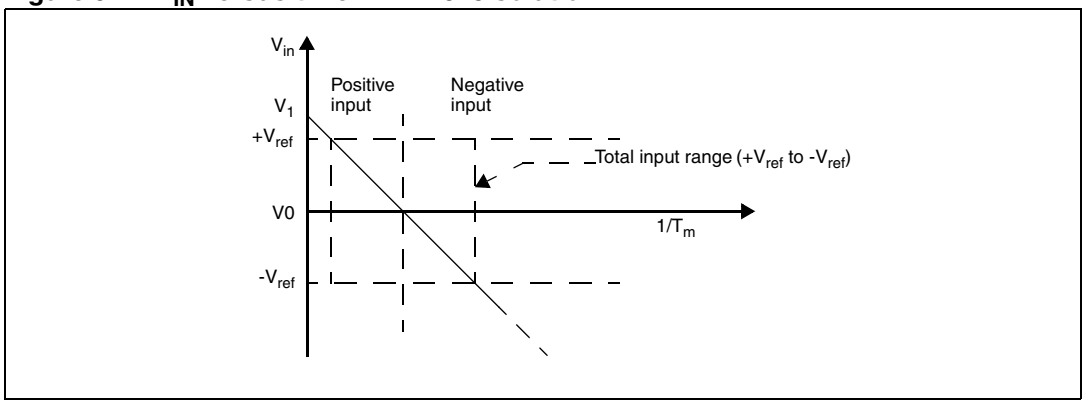


The advantage of a dual-slope ADC is that it is not dependent on the correction factor for the R*C product. However, the input offset voltage problem still persists and this ADC also requires a dual supply op-amp to be able to measure positive and negative voltages.

6.3 Solution presented in this application note

In this application note, a single supply ADC for positive and negative input voltages is described. It's input voltage is proportional to the inverse of the time measured. We can see in *Figure 9* below that as the input voltage becomes closer to V1, the conversion time also increases. For an input of V_1, the conversion time is infinite ($1/T_m = 0$ in *Figure 9*). So the input voltage range depends on the value of V1 and the maximum delay that the application can tolerate.

Figure 9. V_{IN} versus time in AN2615 solution



1. $V_{in} = V_1 - (R * C) * (V_3 - V_2) / T_m$

The significant advantage of this ADC is its ability to measure positive and negative input voltages operating from single supply, while other solutions require a dual supply. Also this converter does not require any negative voltage reference. Again, as in the single slope converter, the major sources of error are the correction factor for R*C product and the input offset voltage.

As shown *Figure 9*, the ADC is capable of measuring the input voltage ranging $+V_{ref}$ to $-V_{ref}$, where the absolute value of V_{ref} is mod (V_{ref}) < V_1 so the input voltage range depends on the value of V_1.

7 Error analysis/constraints

This ADC can be used for measuring any slowly varying input (voltage/current), for example battery monitoring, and for measuring positive and negative input voltages. But, besides the need for accurate power supply and voltage references, the following factors also affect the accuracy of the conversion.

7.1 Input offset voltage

As mentioned previously, the output offset voltage is subtracted from the input, but the input offset voltage of the op-amp (Amp) still remains present and is directly added to V_1. For measurement purposes, let us refer to the input offset voltage of the op-amp as K_{offset}.

7.2 Correction factor for the product of R*C

As the value of the R and C changes with time and temperature, the factor R * C also changes. Let the correction factor be K_{gain}.

Then eq(5) becomes,

$$V_{in} = V1 + K_{offset} - K_{gain} * (R * C) * (V3 - V2)/Tm \quad \text{---------- (6)}$$

The coefficients K_{offset} and K_{gain} can be calculated by measuring T_m for two known input values. These factors can also be compensated by software calibration techniques (like using look-up tables or storing some known values). In the present example the first method is used to calculate these coefficients.

7.3 Value of charging resistance R

If the charging resistance ‘R’ is too high then the current ‘I’ is comparable to the input bias current of the op-amp, which can affect the output. Also if it is too low then the current flowing through it is significant so the capacitor is charged very fast. This affects the measurement accuracy of the ADC.

7.4 Charging capacitor C

Up to this point we have assumed that capacitor C discharges completely from the previous conversion. However, this is not so in actual practice and a few millivolts worth of charge (which adds to the offset voltage), may remain on the capacitor. This effect is called capacitor dielectric absorption and varies depending on the capacitor's dielectric material voltage to which it was charged during the last charge cycle and the amount of time the capacitor has had to discharge. Also due to this effect, the output of the capacitor may not be linear over the whole conversion range. So it is very important to choose the right capacitor for your requirements. While Teflon capacitors exhibit the lowest dielectric absorption, polystyrene and polyethylene are also excellent. Ceramic, glass and mica are fair, while tantalum and electrolytic types are poor choices for A/D applications.

Also, as integrating ADC’s are dependent on the integration of the current flowing through capacitor C, they do the averaging. So, the larger the value of the capacitor, the longer the

conversion time and the better the accuracy. In conclusion, there is always a trade-off between conversion time and accuracy.

7.5 16-bit timer

A 16-bit timer is used as the counter that measures the conversion time. Overflows are also taken into account, so we can also use an 8-bit timer. The resolution of the ADC depends on the operating frequency of the timer.

7.6 Effect of temperature

The value and characteristics of each component varies with temperature. The effect of temperature can be broadly categorized as ‘offset drift’ and ‘gain drift’. So we need to compensate the ADC for each significant change in temperature.

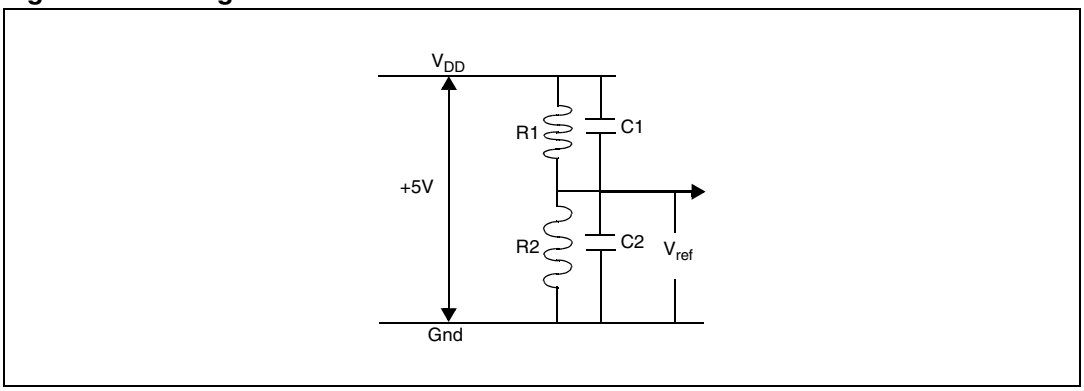
7.7 Comparator

The comparators are the cornerstone of the A/D conversion process. The ability of the comparator to detect small voltage/current changes makes the comparator very important in the A/D conversion process. Any degradation of the intended behaviour of the comparator, which is most usually caused by unwanted noise, leads to the degradation of the ADC’s ability to measure low voltages.

8 Voltage references

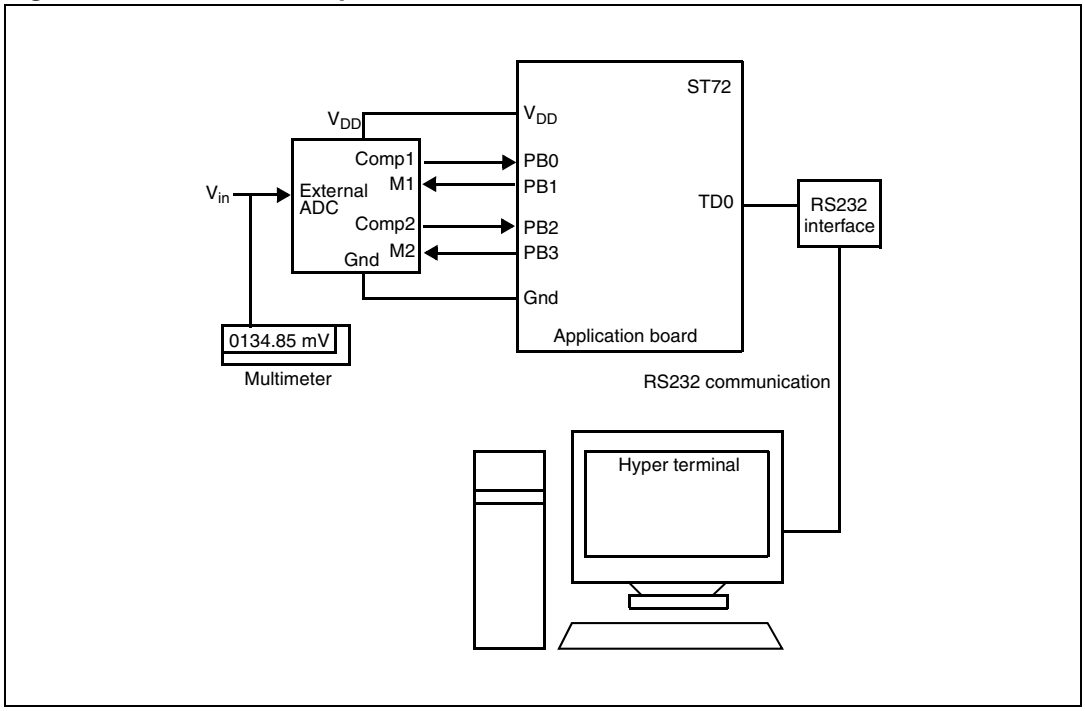
The following circuit is used to produce the different voltage references.

Figure 10. Voltage reference



9 Hardware setup

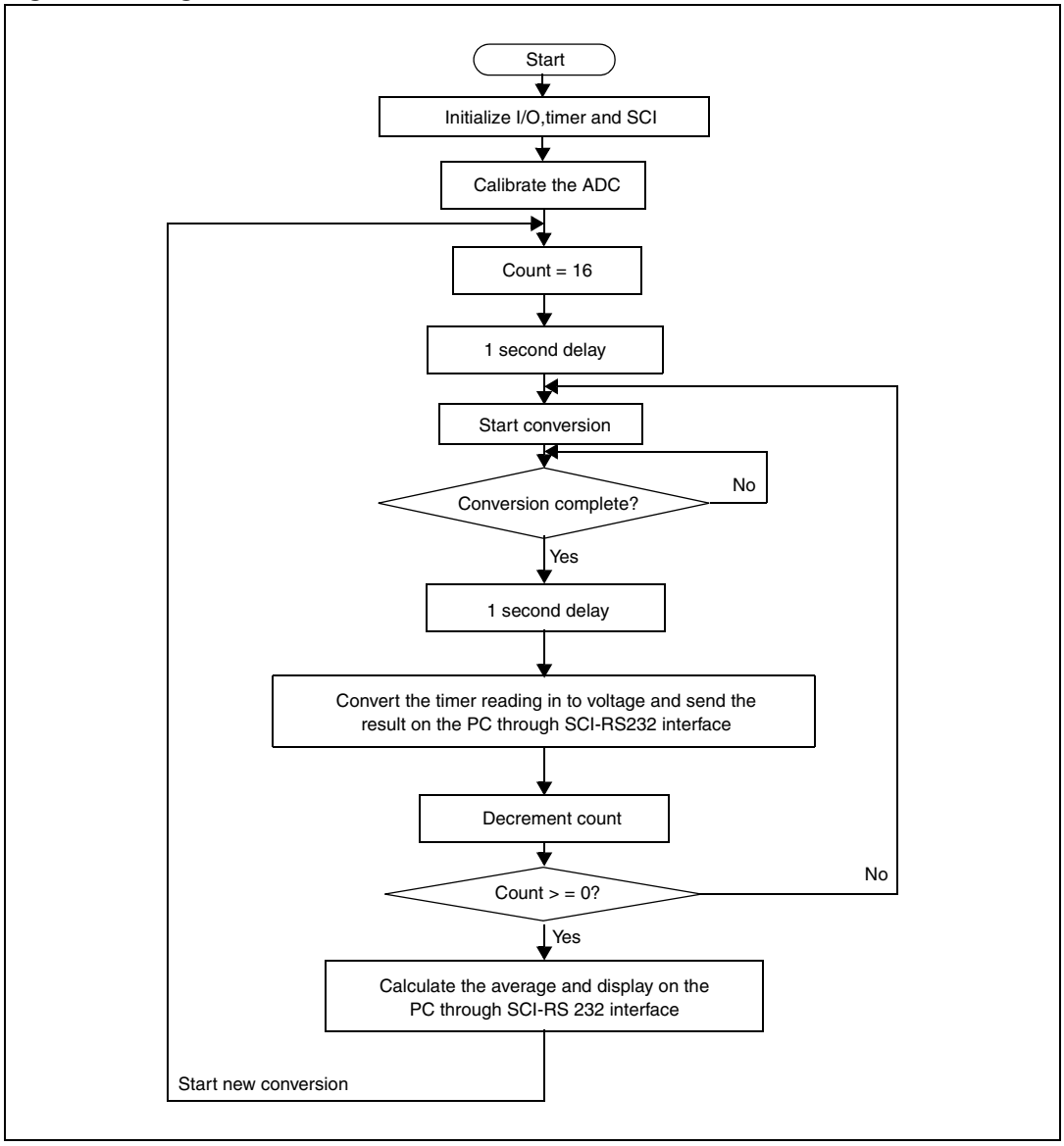
Figure 11. Hardware setup



The external ADC is interfaced to the ST7 microcontroller The input capture pins PB0 and PB2 are used for capturing the pulse from the comparators at two instants (when the output is equal to V_2 and V_3 respectively), while PB1 and PB3 are used for controlling the voltage at the gate of the M1 and M2 switches (on/off the MOSFET). The results of the A/D conversion are displayed on the Windows hyper terminal application through an RS232-SCI interface. The general schematics of the board are given in *Appendix B: Application board schematics on page 31*.

10 Algorithm

Figure 12. Algorithm flowchart



11 Result

The result is given for a capacitor value of 100 µF. So the conversion time is long. The conversion time can be reduced by choosing a capacitor with a lower value but accuracy is also reduced. Other parameters are as follows:

R = 10 K, V_1 = 1.5 V, V_2 = 2V and V_3 = 3 V

So:

R * C = (10 K) * (100 µF) = 1 s

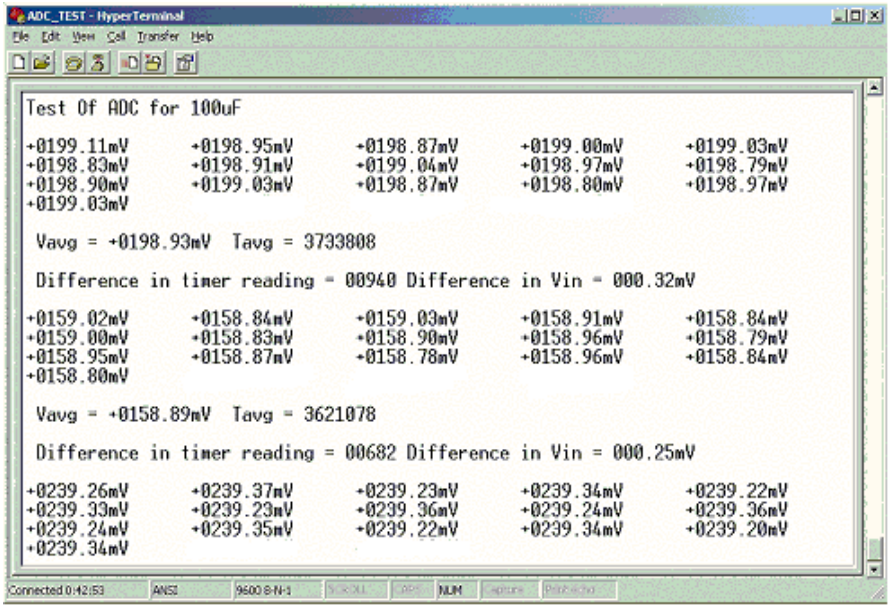
The input range is taken as +1V to -1V, where mod (V_{ref}) (= 1 V) is less than V_1.

The conversion time is in the range 1 to 3 s. The settling time (as shown in *Figure 3: Timing diagram on page 8*) is fixed at 1s. The ADC is calibrated by reading two known input voltages afterwhich K_{offset} and K_{gain} are calculated. The input voltage V_{in} is taken from a voltage source.

11.1 Positive input

In *Figure 13*, an example of the readings measured by the converter, which are sent to the hyper terminal, are shown. T_{avg} is the average of 16 conversions, and V_{avg} is the calculated value in terms of voltage. The difference of the maximum and minimum value among the 16 values is also shown.

Figure 13. Results for positive input



In *Table 1*, the readings are shown for positive input voltages ranging from 0 to 1 V. V_{in} is the voltage measured by the multimeter. $V_{measured}$ (equal to V_{avg}) is the average voltage measured by the converter in a loop of 16. The last column shows the difference in the maximum and minimum readings of the values measured by the converter in the loop. This shows the variations recorded in the readings.

Table 1. Results for positive input voltages

Sl no	V_{in} (mV) (taken from multimeter)	$V_{measured}$ (mV)	Difference (mV) ($V_{measured}$ - V_{in})	Error in max and min input measured in the loop (mV)
1	8.93	8.93	0	0.45
2	18.94	18.98	0.04	0.25
3	28.82	28.87	0.05	0.21
4	38.72	38.78	0.06	0.39
5	49.07	49.13	0.06	0.46
6	58.93	59.02	0.09	0.38
7	68.82	68.92	0.1	0.08
8	79.12	79.25	0.13	0.39
9	88.98	89.07	0.09	0.33
10	98.85	98.98	0.13	0.12
11	108.75	108.9	0.15	0.37
12	119.05	119.19	0.14	0.43
13	128.95	129.13	0.18	0.29
14	138.57	138.76	0.19	0.24
15	158.75	158.96	0.25	0.25
16	178.97	179.18	0.21	0.4
17	198.68	198.91	0.23	0.1
18	218.83	219.1	0.27	0.37
19	239.08	239.35	0.27	0.34
20	258.55	258.83	0.28	0.14
21	278.8	279.11	0.31	0.19
22	299.02	299.34	0.32	0.31
23	318.68	319.09	0.41	0.37
24	338.93	339.29	0.36	0.35
25	358.38	358.78	0.4	0.39
26	378.62	378.98	0.36	0.36
27	398.85	399.25	0.4	0.27
28	438.84	439.23	0.39	0.15
29	478.64	478.93	0.29	0.35

Table 1. Results for positive input voltages (continued)

Sl no	V_{in} (mV) (taken from multimeter)	$V_{measured}$ (mV)	Difference (mV) ($V_{measured}$ - V_{in})	Error in max and min input measured in the loop (mV)
30	498.75	499.23	0.48	0.09
31	519	519.41	0.41	0.32
32	538.69	539.1	0.41	0.28
33	558.91	559.3	0.39	0.11
34	578.63	579.03	0.4	0.3
35	598.65	599.01	0.36	0.28
36	638.6	638.99	0.39	0.26
37	678.93	679.3	0.37	0.14
38	718.6	718.93	0.33	0.14
39	758.61	758.93	0.32	0.23
40	798.53	798.83	0.3	0.17
41	838.7	838.94	0.24	0.19
42	858.49	858.68	0.19	0.2
43	878.55	878.72	0.17	0.13
44	898.76	898.92	0.16	0.19
45	918.53	918.61	0.08	0.13
46	938.46	938.55	0.09	0.15
47	958.68	958.72	0.04	0.1
48	978.4	978.38	-0.02	0.14
49	998.63	998.56	-0.07	0.14
50	1018.8	1018.68	-0.12	0.18

Figure 14 shows the relationship between the voltage measured by the ADC $V_{measured}$ (average of the 16 readings measured by the converter) and the input voltage V_{in}.

Figure 14. Measured vs input for positive voltages

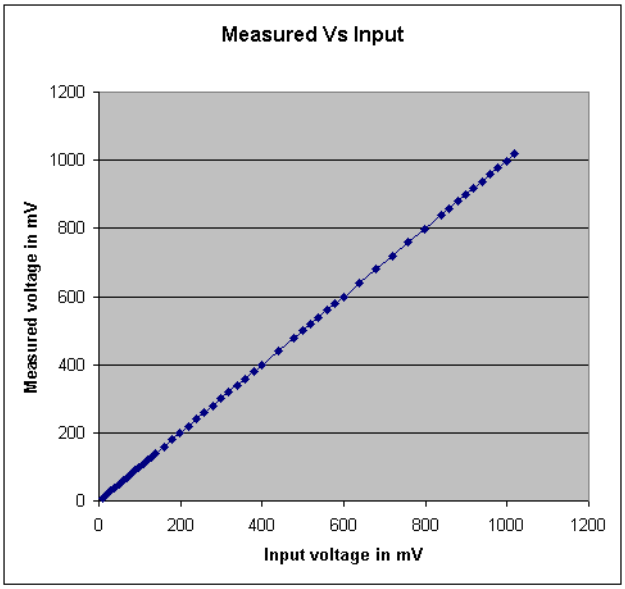
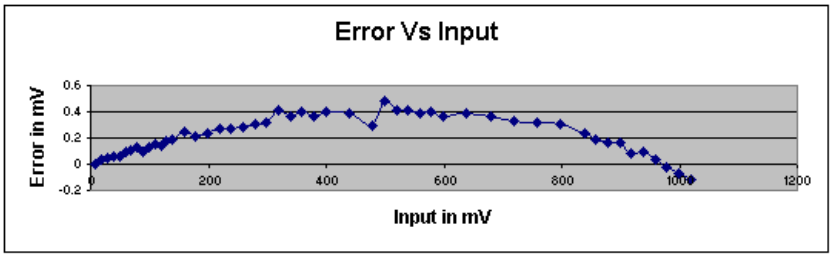


Figure 15 shows the relationship between the error voltage (as given in *Table 1* in the column 'difference ($V_{measured}$ - V_{in}')) and the input voltage V_{in}.

Figure 15. Error vs input for positive input voltages



Note: It may be seen from the readings in Table 1 and Figure 15, that for the positive input between 0 to 1 V the maximum error is around 500 µV for an average of 16 conversions. Thus the difference between the maximum and minimum values in a loop of 16 is around 500 µV. This shows that averaging has increased accuracy. The accuracy without averaging is approx 1mV.

The variations of the 16 values may be due to changes in the input voltage itself, as the time taken for 16 readings is very long (around 16 s).

11.2 Negative input

Similar to the positive input voltages, the readings for negative input voltage are taken in a loop of 16 as shown in *Figure 16*.

Figure 16. Results for negative input

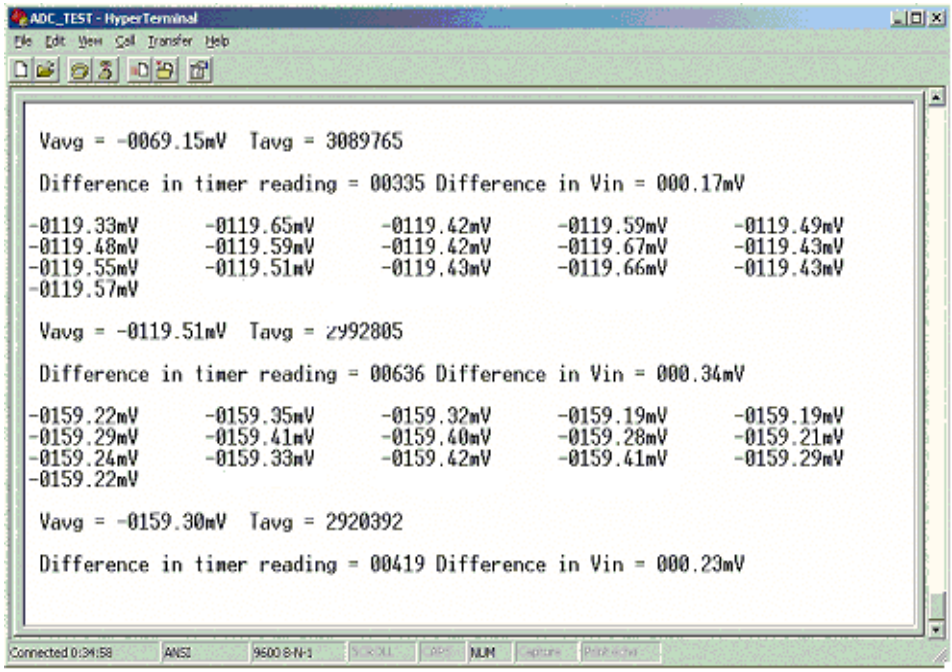


Table 2 shows the readings for negative input voltages ranging from 0 to -1 V with the same parameter notations as *Table 1: Results for positive input voltages on page 20*.

Table 2. Results for negative input voltages

Sl no	V_{in} (mV) (taken from multimeter)	$V_{measured}$ (mV)	Difference (mV) ($V_{measured}$ - V_{in})	Error in max and min input measured in the loop (mV)
1	-9.23	-9.17	0.06	0.43
2	-18.92	-18.84	0.08	0.14
3	-28.96	-29.04	-0.08	0.27
4	-38.76	-38.89	-0.13	0.38
5	-49.03	-49.14	-0.11	0.37
6	-58.88	-59	-0.12	0.24
7	-68.74	-68.9	-0.16	0.8
8	-79.03	-79.2	-0.17	0.22
9	-88.88	-89.06	-0.18	0.34
10	-98.76	-98.96	-0.2	0.4
11	-128.87	-129.13	-0.26	0.32
12	-148.76	-149.07	-0.31	0.32
13	-178.9	-179.21	-0.31	0.39
14	-198.6	-198.94	-0.34	0.11
15	-218.73	-219.12	-0.39	0.43
16	-248.59	-249.04	-0.45	0.2
17	-268.81	-269.32	-0.51	0.46
18	-298.91	-299.51	-0.6	0.15
19	-318.61	-319.25	-0.64	0.38
20	-348.67	-349.37	-0.7	0.37
21	-378.42	-379.23	-0.81	0.23
22	-398.71	-399.57	-0.86	0.48
23	-418.45	-419.33	-0.88	0.25
24	-448.52	-449.5	-0.98	0.47
25	-478.36	-479.41	-1.05	0.26
26	-498.56	-499.69	-1.13	0.4
27	-538.52	-539.73	-1.21	0.38
28	-578.4	-579.8	-1.4	0.47
29	-618.63	-620.1	-1.47	0.19
30	-658.52	-660.17	-1.65	0.53
31	-698.51	-700.28	-1.77	0.26
32	-738.65	-740.44	-1.79	0.16

Table 2. Results for negative input voltages (continued)

Sl no	V_{in} (mV) (taken from multimeter)	$V_{measured}$ (mV)	Difference (mV) ($V_{measured}$ - V_{in})	Error in max and min input measured in the loop (mV)
33	-778.54	-780.59	-2.05	0.37
34	-818.25	-820.42	-2.17	0.43
35	-858.27	-860.61	-2.34	0.56
36	-898.57	-901.07	-2.5	0.2
37	-938.31	-940.94	-2.63	0.67
38	-978.21	-981.03	-2.82	0.43

Figure 17 shows the relationship between measured voltages $V_{measured}$ (average of the 16 readings measured by the converter) and input voltage V_{in} (as measured by the multimeter) for negative voltages.

Figure 17. Measured vs input for negative voltages

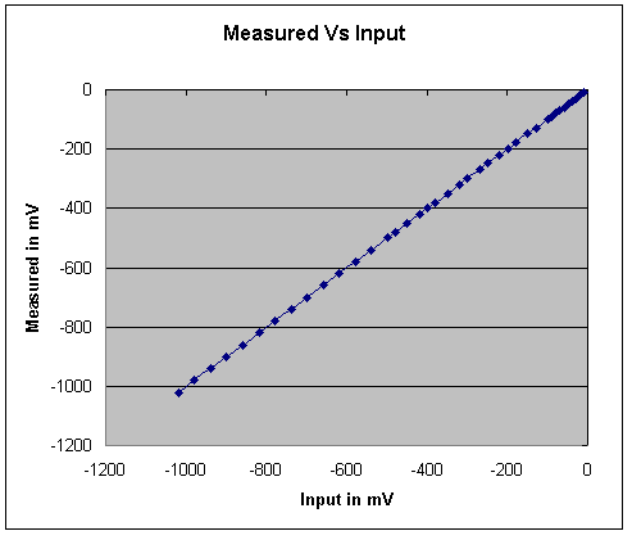


Figure 18. Error vs input for negative input voltages

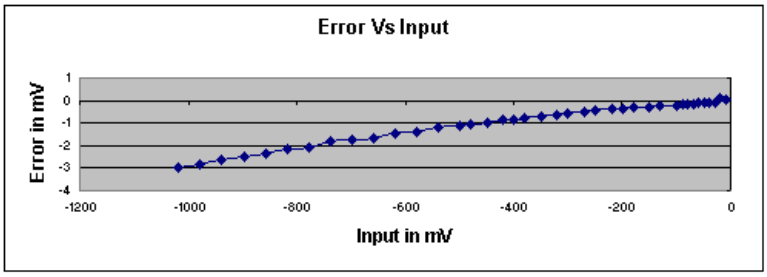


Figure 18, shows that for negative input voltages varying from 0 to -1 V, the maximum error is around -2.89 mV for -1 V input. An error of 0.5 mV occurs for an input value of -269 mV

and it increases gradually afterwards. The maximum difference between the maximum and minimum value in a loop is around 600 µV. So, the accuracy of the average value measured is around 3 mV. Without averaging, accuracy is around 3.6 mV.

11.3 Effect of the capacitor value

As discussed in *Section 7: Error analysis/constraints on page 14*, reducing the R*C time constant by reducing the value of R or C, reduces the accuracy. Readings were taken with a 10 µF capacitor and accuracy of the ADC was found to be reduced. *Figure 19* gives an example of readings with a 10 µF capacitor.

Figure 19. Results for positive input with a 10 µF capacitor

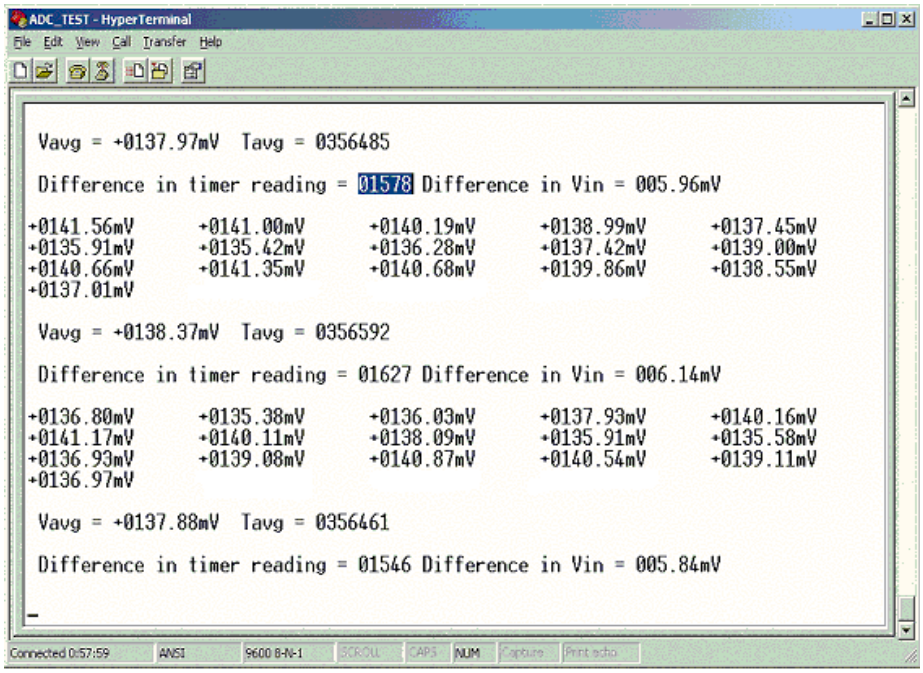


Figure 19 shows that variation in the readings taken in a loop of 16 is around 5 - 6 mV which is approximately 10 times higher than the readings for the 100 µF. This indicates that there is always a trade-off between conversion time and the desired accuracy.

12 Conclusion

This application note presents a technique for implementing a positive supply ADC, capable of measuring slowly-varying positive and negative input voltages with high precision.

Accuracy of the converter depends on the different parameters involved. Greater accuracy can be achieved with careful board design, more precise components and by taking into consideration all the factors discussed in the document.

13 References and bibliography

The following articles and reports provide useful information:

1. AN1636, Understanding and minimising ADC conversion errors
2. Comparators and bistable circuits, ECE60L lecture notes, winter 2002
3. Selecting the right buffer operational amplifier for an A/D converter, application report SLOA050, August 2000, Texas instruments
4. MOSFET device physics and operation by T Ytterdal, Y Cheng and TA Fjeldly, © 2003, John Wiley and sons, ISBN: 0-471-49869-6
5. Comparators and offset cancellation techniques by Jieh-Tsorng Wu, 2003, National Chiao-Tung University Department of Electronics Engineering
6. Reducing noise in data acquisition systems by Fred R Schraff, PE IOtech Inc., adapted from an article that appeared in the April 1996 edition of SENSORS magazine, Helmers Publishing
7. How do ADCs work? by Martin Rowe, senior technical editor, 7/1/2002, Test and Measurement World

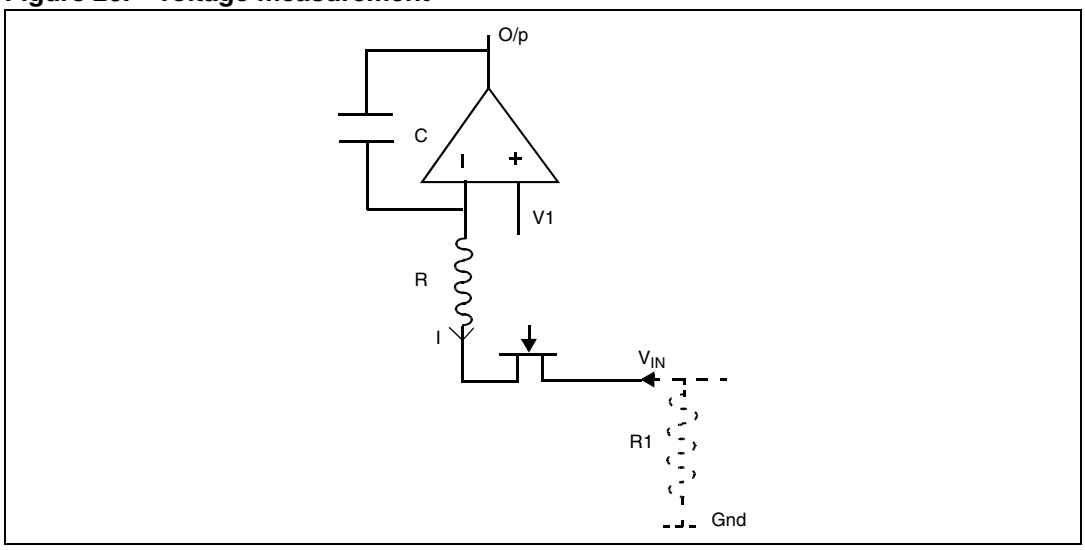
Appendix A Input stage conditions

The ADC described here can be used for measuring both voltage and current with slight changes in set-up in each case.

A.1 Case 1: Voltage measurement

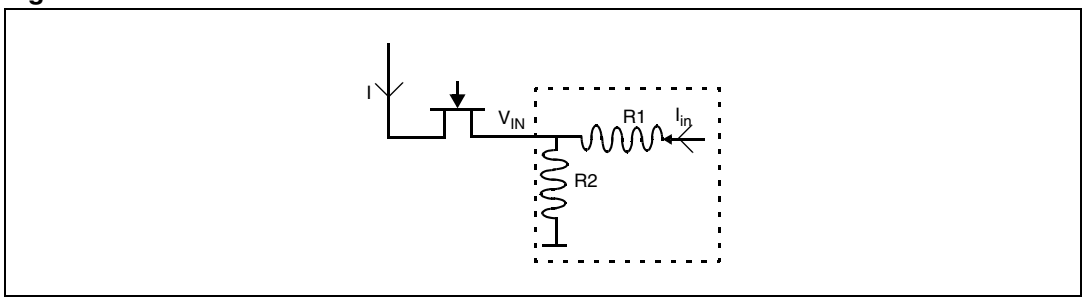
There are two ways in which the input voltage appears at the ADC input. The first way is that input comes directly from a voltage source as shown in *Figure 20*.

Figure 20. Voltage measurement



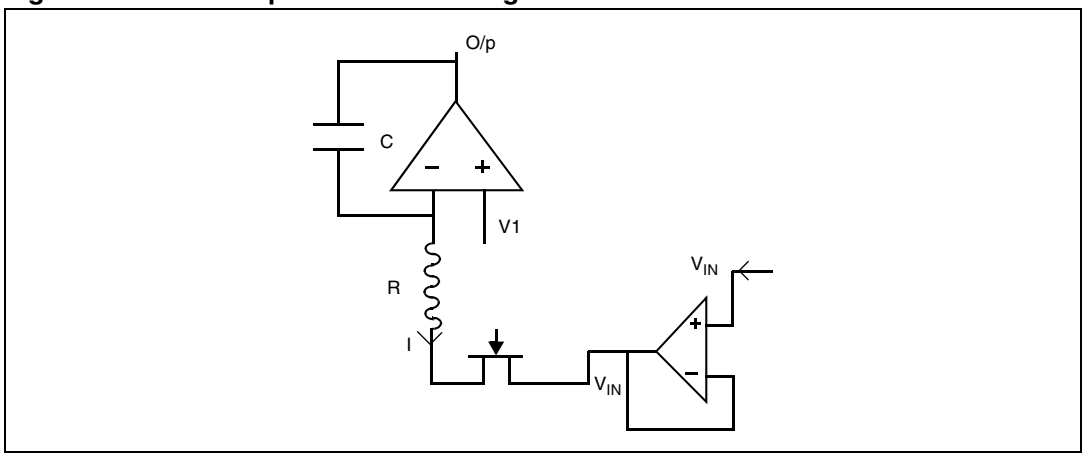
In *Figure 20* above, there are no problems. However, if the input comes from a potential divider circuit as shown in *Figure 21*, the effective input voltage V_{in} is the result of the drop across R2 due to the current I and current I_{in}.

Figure 21. Potential divider



In this case an input buffer has to be used to overcome the problem (see *Figure 22: Use of input buffer for voltage measurement on page 30*).

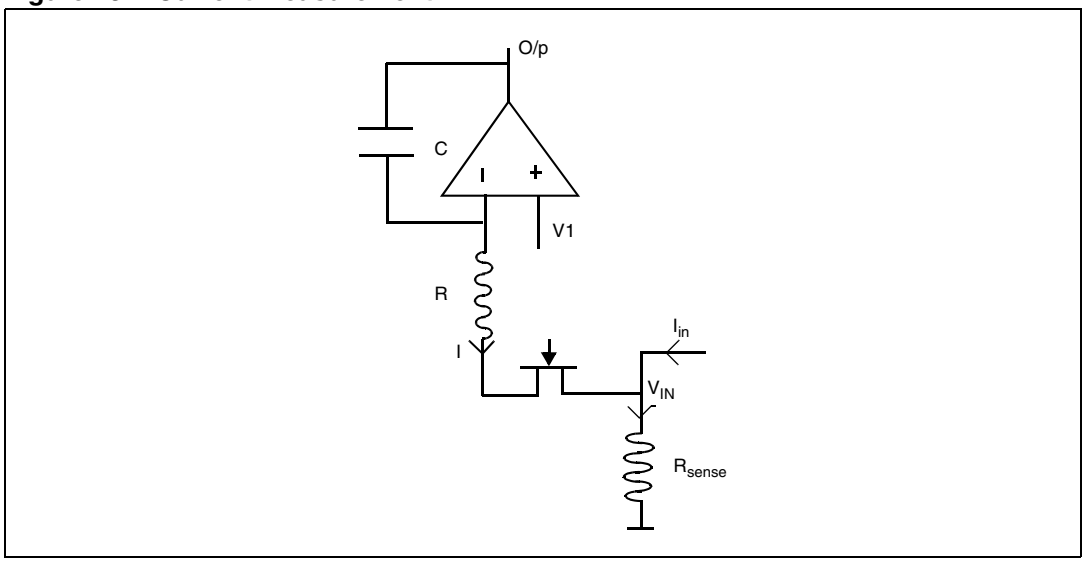
Figure 22. Use of input buffer for voltage measurement



A.2 Case 2: Current measurement

Figure 23 shows the current measurement circuit.

Figure 23. Current measurement



$V_{in} = (I_{in} + I) * R_{sense} = I_{in} * (1 + I/I_{in}) * R_{sense}$ ---------- (1)

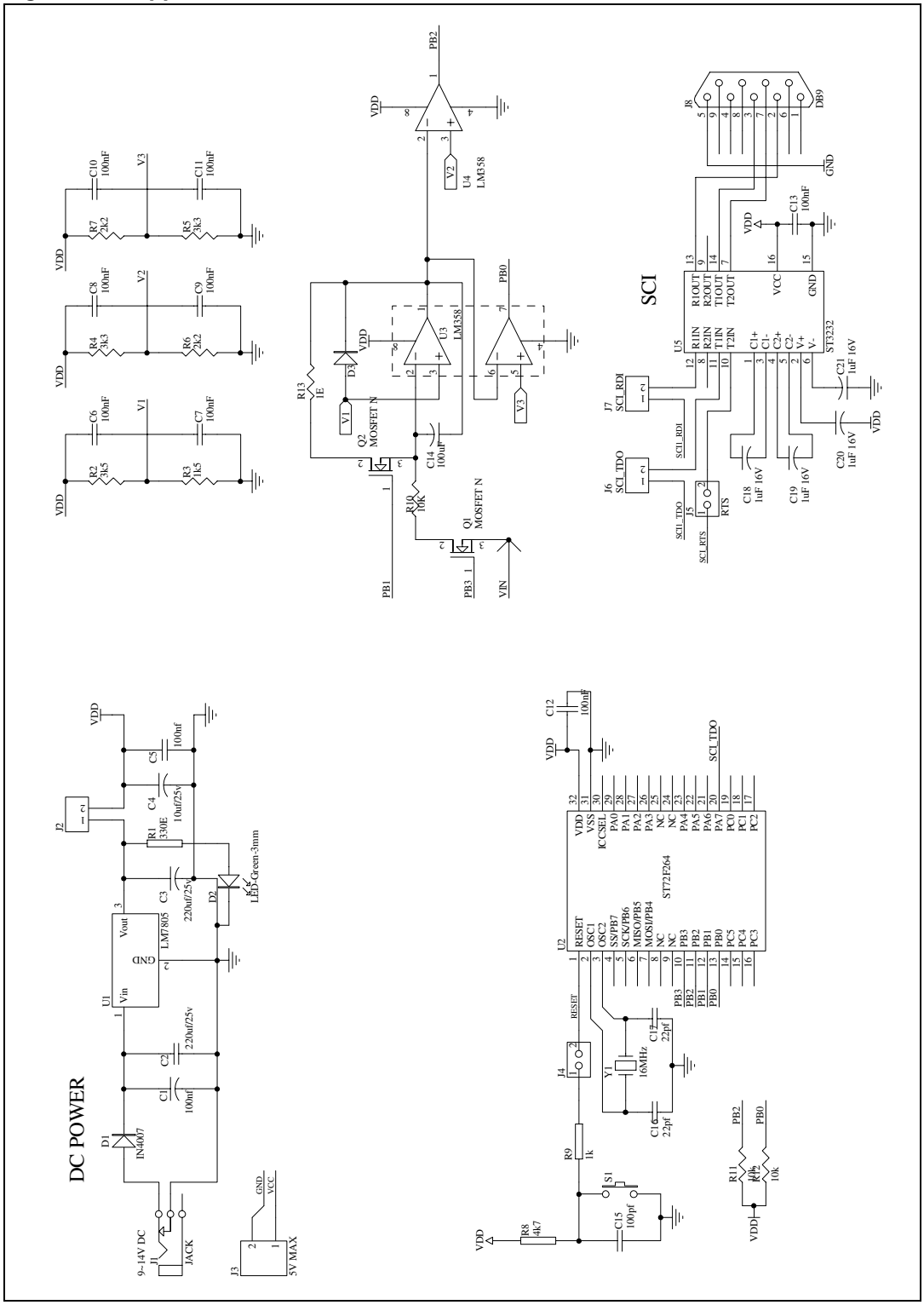
$I = (V_1 - V_{in})/R = V_1/(R * (1 + R_{sense}/R))$ ---------- (2)

The following points should be kept in mind while using R_{sense}:

1. R_{sense} should be chosen to correspond with the range of the current to be measured.
2. R_{sense} affects the effective value of current I. To minimize its effect, it should be negligible compared to R. Otherwise ADC has to be compensated.

Appendix B Application board schematics

Figure 24. Application board schematics



Appendix C Bill of materials

Table 3 gives the bill of material for each block of the schematics shown in *Figure 24*.

Table 3. Bill of materials

Block	Designator	Part type/number	Description
ADC	R13	1E	Resistor
	R10	10 kΩ	Resistor
	U3	LM358	Dual op-amp
	U4	LM358	Dual op-amp
	C14	100 µF	Capacitor
	Q2	STB100NF03L	N - MOSFET
	Q1	STB100NF03L	N - MOSFET
	D3	IN4007	Diode
Voltage references	C8	100 nF	Capacitor
	C9	100 nF	Capacitor
	C10	100 nF	Capacitor
	C11	100 nF	Capacitor
	C7	100 nF	Capacitor
	C6	100 nF	Capacitor
	R6	2.2 kΩ	Resistor
	R7	2.2 kΩ	Resistor
	R5	3.3 kΩ	Resistor
	R4	3.3 kΩ	Resistor
	R2	3.5 kΩ	Resistor
	R3	1.5 kΩ	Resistor
SCI	U5	ST3232	Line driver
	C18	1µF 16 V	Capacitor
	C19	1µF 16 V	Capacitor
	C20	1µF 16 V	Capacitor
	C21	1µF 16 V	Capacitor
	J5	jumper	CON-2
	J7	jumper	CON-2
	J6	jumper	CON-2
	C13	100 nF	Capacitor
	J8	DB9	9 pin connector

Table 3. Bill of materials (continued)

Block	Designator	Part type/number	Description
Micro setup	R12	10 kΩ	Resistor
	R11	10 kΩ	Resistor
	U2	ST72F264	Micro-controller
	C12	100 nF	Capacitor
	Y1	16 MHz	Crystal oscillator
Crystal	C17	22 pF	Capacitor
	C16	22 pF	Capacitor
	R9	1 kΩ	Resistor
Reset	R8	4.7 kΩ	Resistor
	C15	100 pF	Capacitor
	S1	Push button	Micro switch
	J4	CON-2	jumper
DC power	C4	10 µF/25 V	Capacitor
	C5	100 nF	Capacitor
	C1	100 nF	Capacitor
	C3	220 µF/25 V	Capacitor
	C2	220 µF/25 V	Capacitor
	R1	330E	Resistor
	J1	DC - Jack	DC - Jack
	D2	LED 3mm	LED-green
	U1	LM7805	Voltage regulator
	D1	IN4007	Diode
	J2	jumper	CON-2
	J3	Power connector	2 pin connector

Appendix D Software flow

The f_{CPU} chosen is 8 MHz. K_{offset} and K_{gain} are calculated by taking a reading for two known inputs. The flow of software, used to implement the algorithm, is as follows:

1. The I/O pins, timer, SCI (Tx @ 9600 baud rate) and some global variables used in the ADC are initialized.
2. A string is transmitted to check that the SCI is working well.
3. Settling time is fixed at 1 s for f_{CPU} = 8 MHz.
4. Some initial readings are taken and ignored while the ADC stabilizes.
5. The control enters an infinite loop.
6. Inside the infinite loop, there is a loop in which the ADC captures the timer values 17 times. However, the first reading is ignored.
7. The remaining 16 captured values are converted into corresponding voltages (up to 10 µV precision) and then transmitted to a PC for display by the hyper terminal after being converted into a buffer of ASCII characters.
8. The average of 16 timer readings is taken and sent to the hyper terminal as a time value and a corresponding voltage in the same manner as described above.
9. The difference between the maximum and minimum captured value is also sent to the hyper terminal in the same way as in step 8.
10. The software enters an ‘IF’ loop ‘if (mCount == 18)’, where the ADC is reset in order to measure the next input value. Again, a few readings are ignored while the ADC stabilizes. The counter and other global variables are also initialized.
11. The software re-enters the loop of 17 conversions and executes step 6 to step 9. This process continues until the system is reset manually.

D.1 Code size

The software given is for guidance only. Here the display is done for up to 10 µV precision. The user can modify and use their own code for display of the data. *Table 4* summarizes the code size. Depending on the compiler and memory placement, these values can change. The RAM requirements are not provided and the user has the choice to place the variables as global or local.

Table 4. Code size

No.	Function name	Code size (bytes)
ADCSys		
1	Acquisition	128
2	Start_Capturing	7
3	Reset_ADC	5
4	ADC_InitializeVar	29
5	IsCaptured	13
6	Delay_Second	44
7	IO_Init	37
8	TimerA_Init	47
9	Timer_Interrupt_Routine	170
Main		
10	main	1493
11	TIMERA_IT_Routine	38
12	Conversion_TimerReadingToREALInput	116
13	SCI_Init	25
14	SCI_SendBuffer	30
15	SCI_IsTransmissionCompleted	8
16	Dummy_Capturing	26

Note: Some floating point operations are used in this software for display purposes only. It is left to the user to use the floating point operation or not as per his application requirement.

14 Revision history

Table 5. Document revision history

Date	Revision	Changes
23-Aug-2007	1	Initial release

Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries (“ST”) reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST’s terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST’S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER’S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com